

DF005M - DF10M

1.0A GLASS PASSIVATED BRIDGE RECTIFIERS

Features

- Glass Passivated Die Construction
- Low Forward Voltage Drop, High Current Capability
- Surge Overload Rating to 50A Peak
- Designed for Printed Circuit Board Applications
- UL Listed Under Recognized Component Index, File Number E94661
- Lead Free Finish, RoHS Compliant (Date Code 0532+) (Note 3)

DF-M						
Dim	Min	Max				
Α	7.40	7.90				
В	6.20	6.50				
С	0.22	0.30				
D	1.27	2.03				
E	7.60	8.90				
G	3.81	4.69				
Н	8.13	8.51				
J	2.40	3.40				
K	5.00	5.20				
L	0.46	0.58				
All Dimensions in mm						

Mechanical Data

- Case: DF-M
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020C
- Terminals: Finish Tin. Solder Plated Leads, Solderable per MIL-STD-202, Method 208 @3
- Polarity: As Marked on Case
- Marking Information: Type Number, See Page 3
- Weight: 0.38 grams (approximate)

Maximum Ratings and Electrical Characteristics

@T_A = 25°C unless otherwise specified

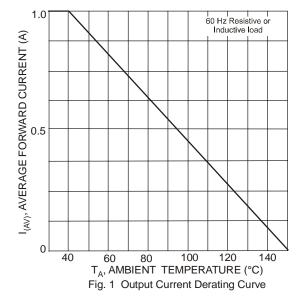
Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

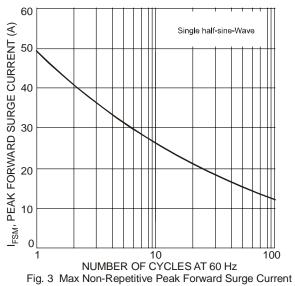
Characteristic		Symbol	DF 005M	DF 01M	DF 02M	DF 04M	DF 06M	DF 08M	DF 10M	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RMM} V _{RWM} V _R	50	100	200	400	600	800	1000	V
RMS Reverse Voltage		V_{RMS}	35	70	140	280	420	580	700	V
Average Rectified Output Current	@ T _A = 40°C	lo	1.0					Α		
Non-Repetitive Peak Forward Surge Current, 8.3 m Single Half Sine-Wave Superimposed on Rated Lo		I _{FSM}				50				А
Forward Voltage (per element)	@ I _F = 1.0 A	V_{FM}	1.1				V			
Peak Reverse Current at Rated DC Blocking Voltage (per element)	@ T _A = 25°C @ T _A = 125°C	I _{RM}	10 500				μΑ			
I ² t Rating for Fusing (t<8.3ms)		l ² t				10.4				A ² s
Typical Total Capacitance per element	(Note 1)	C _T	25				pF			
Typical Thermal Resistance, Junction to Ambient	(Note 2)	$R_{\theta JA}$	40			°C/W				
Operating and Storage Temperature Range		T _j , T _{STG}			-6	65 to +15	50			°C

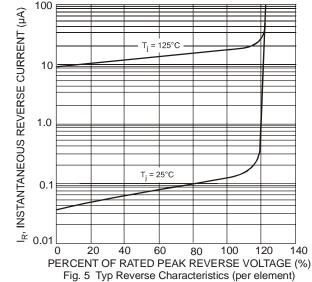
Notes:

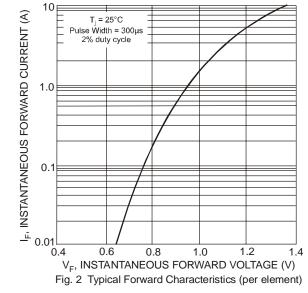
- 1. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 2. Thermal Resistance, junction to ambient, measured on PC board with 5.0mm² (0.03mm thick) land areas.
- 3. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see EU Directive Annex Notes 5 and 7.

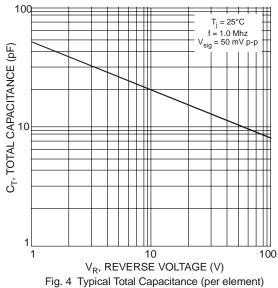












DS21201 Rev. 15 - 2



Ordering Information (Note 4)

Device*	Packaging	Shipping
DFxM	DF-M	Tube

^{*} x = Device type, e.g. DF005M or DF10M, etc.

Notes: 4. For packaging details, visit our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



Office Manufacturers' code marking

XXXXX = Product type marking code, ex: DF10M

YWW = Date code marking

Y = Last digit of year ex: 2 for 2002

WW = Week code 01 to 52

IMPORTANT NOTICE

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to any product herein. Diodes Incorporated does not assume any liability arising out of the application or use of any product described herein; neither does it convey any license under its patent rights, nor the rights of others. The user of products in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on our website, harmless against all damages.

LIFE SUPPORT

Diodes Incorporated products are not authorized for use as critical components in life support devices or systems without the expressed written approval of the President of Diodes Incorporated.